



**Product Change Notification**

Internal Registration Date   
DD.MM.YYYY

**TE Connectivity**

PCN number   
ECR project number

PCN Date   
DD.MM.YYYY

TE would like to inform you of the following change(s) to the listed TE Connectivity Product. In case of any further questions about this change(s), please contact your TE Connectivity Sales Engineer. Affected part, drawing and/or specification numbers are listed on the attached sheet(s).

**General Product Description**  
G-MRCO-051, G-MRCO-055, G-MRCO-050, G-MRCO-056, G-MRCO-052, G-MRCO-057, 10219645-00 and G-MRCO-005  
PCN-2021069

**Description of Changes**

1. Change of Wafer substrate supplier.
2. Change of Wafer substrate diameter.
3. release of additional deposition tool.
4. release of additional etch process.
5. no change of form, fit or function
6. no change in all other process steps

**Reason for Changes**  
*discontinuation of supply goods (wafer substrate) and capacity increase*

**Estimated Dates:**

Last Order Date (Obsolete parts Only):	First Date To Ship (Changed Parts Only):
n/a	3/25/2022
Last Ship Date (Obsolete parts Only)	Last Date for mixed Shipments: (Changed Parts Only)
n/a	n/a

**Part Number(s) being Modified:**

Part Number	Part Discontinued per PCN	Customer Drawing	Alias Part Number(s)	Substitute Part Number	Substitute Alias Part Number(s)	Description Of Difference
n/a	n/a	n/a	n/a	n/a	n/a	n/a

TE Sales Representative   
Email   
Tel

**Change Category**

Product Engineering	
Process Engineering	X
Transfer	
Purchasing	